





BONDING PATTERN

|              |         |  |      |       |                              |   |               |                    |                                    |                |
|--------------|---------|--|------|-------|------------------------------|---|---------------|--------------------|------------------------------------|----------------|
| MODIFICATION |         |  |      |       | NAME<br>32 LEAD FLAT PACKAGE | TOLERANCE<br>UNLESS OTHERWISE SPECIFIED | DRAWN<br>S.SH | CHECKED<br>T.C/S.F | APPROVED<br>T.A                    | DATE<br>AUG.08 |
|              |         |  |      |       | SCALE<br>20/1                | MATERIAL                                |               |                    |                                    |                |
|              |         |  |      |       |                              |   |               |                    |                                    |                |
|              |         |  |      |       |                              |   |               |                    |                                    |                |
|              | CHANGED |  | DATE | DRAWN | CHECKED                      | APPROVED                                |               |                    | KYOCERA CORPORATION<br>KYOTO JAPAN |                |
|              |         |  |      |       |                              |   | DRAWING NO.   |                    | KD-F95793                          |                |